

ESD Protection Diode : TExST23

SOT-23 package



■ Features

1. RoHS compliant and halogen-free
2. Low clamping voltage
3. Low leakage current
4. IEC 61000-4-2 (ESD) 15~30KV (air), 15~30KV (contact)



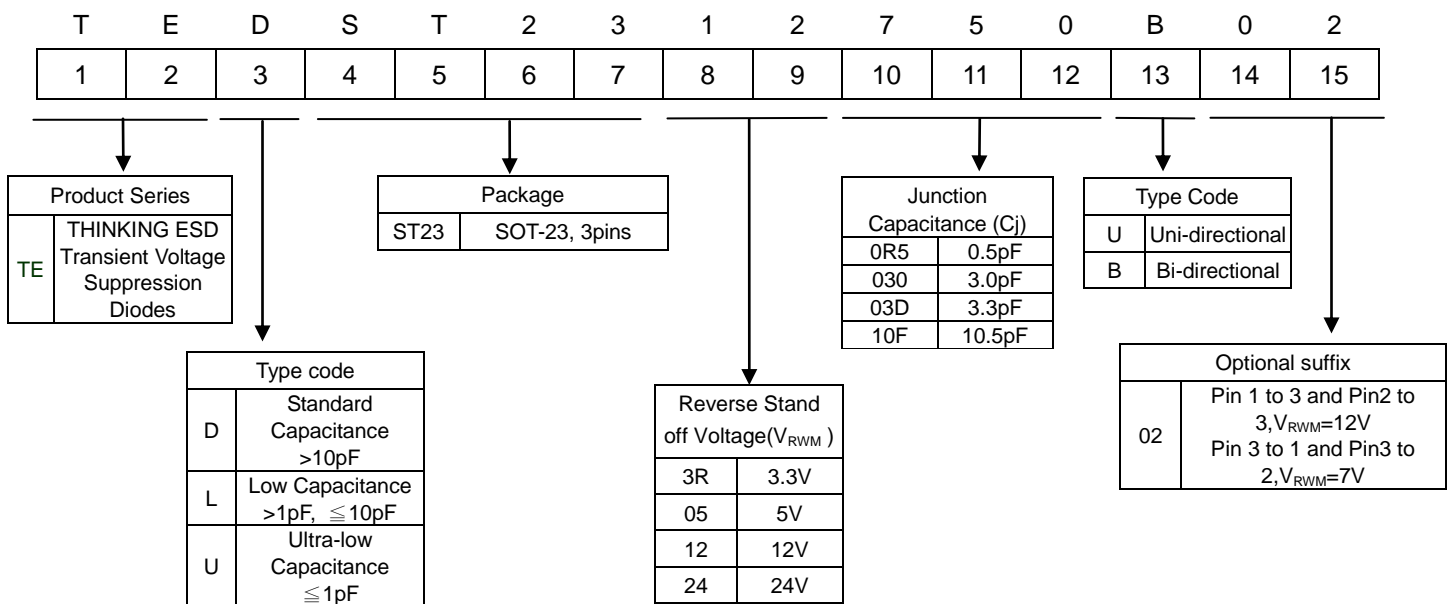
■ Recommended Applications

1. Extended common-mode RS-485
2. Security systems
3. Networks
4. Automatic teller machines

■ Mechanical Data

1. Case: SOT-23, molded plastic meets UL flammability rating 94V-0
2. Meets MSL level 1, per J-STD-020

■ Part Number Code

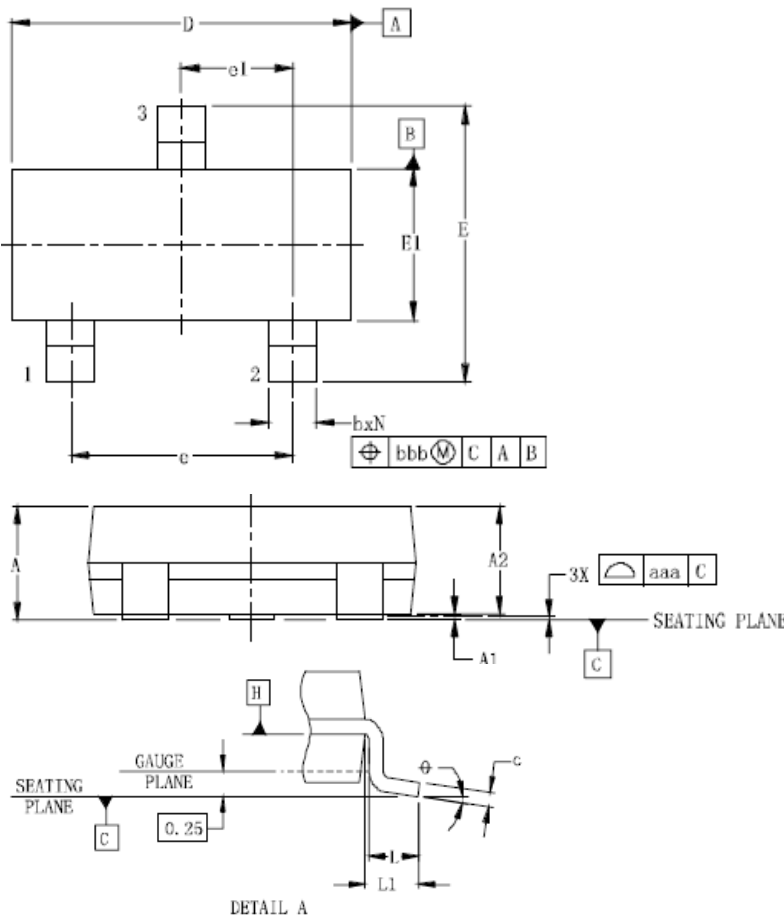


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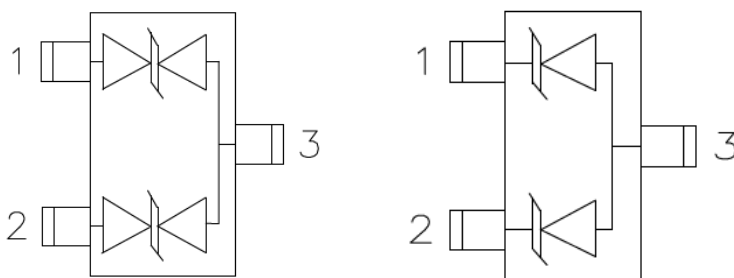
Structures and Dimensions



Unit: mm

Symbol	SOT-23		
	Min	Nom	Max
A	0.89	-	1.12
A1	0.01	-	0.1
A2	0.88	0.95	1.02
b	0.3	-	0.51
c	0.08	-	0.18
D	2.8	2.9	3.04
E	2.1	2.37	2.64
E1	1.2	1.3	1.4
e	1.9BSC		
e1	0.95BSC		
L	0.4	0.5	0.6
L1	-0.55		
N	3		
θ	0°	-	8°
aaa	0.1		
bbb	0.2		

Schematic & PIN Configuration



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■ Electrical Characteristics (T_A=25°C unless otherwise noted)

P/N	Reverse Stand-off Voltage		Reverse Leakage Current			Product Polarity	Marking	Peak Pulse Power	Peak Pulse Current	ESD (contact)	ESD (air)	Operating Temp.	Storage Temp.
	V _{RWM} (V)		I _R (uA)					(8/20μs)	(8/20μs)				
	Pin1to3/ Pin2to3	Pin3to1/ Pin3to2	Pin1to3/ Pin2to3	Pin3to1/ Pin3to2		Uni/Bi	P _{PK} (W)	I _{PP} (A)	KV	KV	T _J (°C)	T _{stg} (°C)	
	Max	Max	Typ.	Max	Max								
TEDSD233R100B	3.3		0.01	0.5		Bi	03C	350	32	±30	±30	-55to+125	-55to+150
TEDST233R201U	3.3		0.01	0.5		Uni	S03	350	32	±30	±30	-55to+125	-55to+150
TEUST23050R7U	5		0.5	1		Uni	5ML	60	3.5	15	15	-55to+125	-55to+125
TEDST2305101B	5		0.01	0.5		Bi	05C	350	26	±30	±30	-55to+125	-55to+150
TEDST2305101U	5		0.01	0.5		Uni	S05	350	26	±30	±30	-55to+125	-55to+150
TEDST2312101B	12		0.01	0.5		Bi	12C	350	15	±30	±30	-55to+125	-55to+150
TEDST2312101U	12		0.01	0.5		Uni	S12	350	15	±30	±30	-55to+125	-55to+150
TEDST2312750B02	12	7		0.05	2	Bi	712	400	17	±30	±30	-55to+125	-55to+150
TEDST2324280B	24			0.2		Bi	24M	300	5	±25	±30	-55to+125	-55to+150
TEDST2324280U	24		0.01	0.5		Uni	S24	350	6	±30	±30	-55to+125	-55to+150

■ Electrical Characteristics (T_A=25°C unless otherwise noted)

TEDSD233R100B		Pin 1 to 3/ Pin 2 to 3			Pin 3 to 1/ Pin3 to 2			Unit	Test Condition
Parameter	Symbol	Min	Typ.	Max	Min	Typ.	Max		
Reverse Working Voltage	V _{RWM}			3.3				V	
Breakdown Voltage	V _{BR}	4						V	IT = 1mA
Reverse Leakage Current	I _R		0.01	0.5				uA	VR = VRWM
Clamping Voltage	V _C		5					V	I _{PP} = 1A (8 x 20μs pulse)
			10					V	I _{PP} = 32A (8 x 20μs pulse)
Junction Capacitance	C _J			100				pF	VR = 0V, f = 1MHz, Pin 1 to Pin 3 or Pin 2 to Pin 3

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TEDST233R201U		Pin 1 to 3/ Pin 2 to 3			Pin 3 to 1/ Pin3 to 2			Unit	Test Condition
Parameter	Symbol	Min	Typ.	Max	Min	Typ.	Max		
Reverse Working Voltage	V_{RWM}			3.3				V	
Breakdown Voltage	V_{BR}	4						V	$I_T = 1\text{mA}$
Reverse Leakage Current	I_R		0.01	0.5				μA	$V_R = V_{RWM}$
Clamping Voltage	V_C		5					V	$I_{PP} = 1\text{A}$ (8 x 20 μs pulse)
			10					V	$I_{PP} = 32\text{A}$ (8 x 20 μs pulse)
Junction Capacitance	C_J			200				pF	$V_R = 0\text{V}$, $f = 1\text{MHz}$, Pin 1 to Pin 3 or Pin 2 to Pin 3
				100				pF	$V_R = 0\text{V}$, $f = 1\text{MHz}$, Pin 1 to Pin 2

TEUST23050R7U		Pin 1 to 3/ Pin 2 to 3			Pin 3 to 1/ Pin3 to 2			Unit	Test Condition
Parameter	Symbol	Min	Typ.	Max	Min	Typ.	Max		
Reverse Working Voltage	V_{RWM}			5				V	
Breakdown Voltage	V_{BR}	6	7	8				V	$I_T = 1\text{mA}$
Reverse Leakage Current	I_R		0.5	1				μA	$V_R = V_{RWM}$
Clamping Voltage	V_C			17				V	$I_{PP} = 3.5\text{A}$ (8 x 20 μs pulse)
Junction Capacitance	C_J		0.7	0.8				pF	$V_R = 0\text{V}$, $f = 1\text{MHz}$, Pin 1 to Pin 3 or Pin 2 to Pin 3

TEDST2305101B		Pin 1 to 3/ Pin 2 to 3			Pin 3 to 1/ Pin3 to 2			Unit	Test Condition
Parameter	Symbol	Min	Typ.	Max	Min	Typ.	Max		
Reverse Working Voltage	V_{RWM}			5				V	
Breakdown Voltage	V_{BR}	6						V	$I_T = 1\text{mA}$
Reverse Leakage Current	I_R		0.01	0.5				μA	$V_R = V_{RWM}$
Clamping Voltage	V_C		7					V	$I_{PP} = 1\text{A}$ (8 x 20 μs pulse)
			11					V	$I_{PP} = 26\text{A}$ (8 x 20 μs pulse)
Junction Capacitance	C_J			100				pF	$V_R = 0\text{V}$, $f = 1\text{MHz}$, Pin 1 to Pin 3 or Pin 2 to Pin 3

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TEDST2305101U		Pin 1 to 3/ Pin 2 to 3			Pin 3 to 1/ Pin3 to 2			Unit	Test Condition
Parameter	Symbol	Min	Typ.	Max	Min	Typ.	Max		
Reverse Working Voltage	V_{RWM}			5				V	
Breakdown Voltage	V_{BR}	6						V	$I_T = 1\text{mA}$
Reverse Leakage Current	I_R		0.01	0.5				μA	$V_R = V_{RWM}$
Clamping Voltage	V_C		7					V	$I_{PP} = 1\text{A}$ (8 x 20 μs pulse)
			11					V	$I_{PP} = 26\text{A}$ (8 x 20 μs pulse)
Junction Capacitance	C_J			200				pF	$V_R = 0\text{V}$, $f = 1\text{MHz}$, Pin 1 to Pin 3 or Pin 2 to Pin 3
				100				pF	$V_R = 0\text{V}$, $f = 1\text{MHz}$, Pin 1 to Pin 2

TEDST2312101B		Pin 1 to 3/ Pin 2 to 3			Pin 3 to 1/ Pin3 to 2			Unit	Test Condition
Parameter	Symbol	Min	Typ.	Max	Min	Typ.	Max		
Reverse Working Voltage	V_{RWM}			12				V	
Breakdown Voltage	V_{BR}	13.3						V	$I_T = 1\text{mA}$
Reverse Leakage Current	I_R		0.01	0.5				μA	$V_R = V_{RWM}$
Clamping Voltage	V_C		15					V	$I_{PP} = 1\text{A}$ (8 x 20 μs pulse)
			24					V	$I_{PP} = 15\text{A}$ (8 x 20 μs pulse)
Junction Capacitance	C_J			100				pF	$V_R = 0\text{V}$, $f = 1\text{MHz}$, Pin 1 to Pin 3 or Pin 2 to Pin 3

TEDST2312101U		Pin 1 to 3/ Pin 2 to 3			Pin 3 to 1/ Pin3 to 2			Unit	Test Condition
Parameter	Symbol	Min	Typ.	Max	Min	Typ.	Max		
Reverse Working Voltage	V_{RWM}			12				V	
Breakdown Voltage	V_{BR}	13.3						V	$I_T = 1\text{mA}$
Reverse Leakage Current	I_R		0.01	0.5				μA	$V_R = V_{RWM}$
Clamping Voltage	V_C		15					V	$I_{PP} = 1\text{A}$ (8 x 20 μs pulse)
			24					V	$I_{PP} = 15\text{A}$ (8 x 20 μs pulse)
Junction Capacitance	C_J			200				pF	$V_R = 0\text{V}$, $f = 1\text{MHz}$, Pin 1 to Pin 3 or Pin 2 to Pin 3
				100				pF	$V_R = 0\text{V}$, $f = 1\text{MHz}$, Pin 1 to Pin 2

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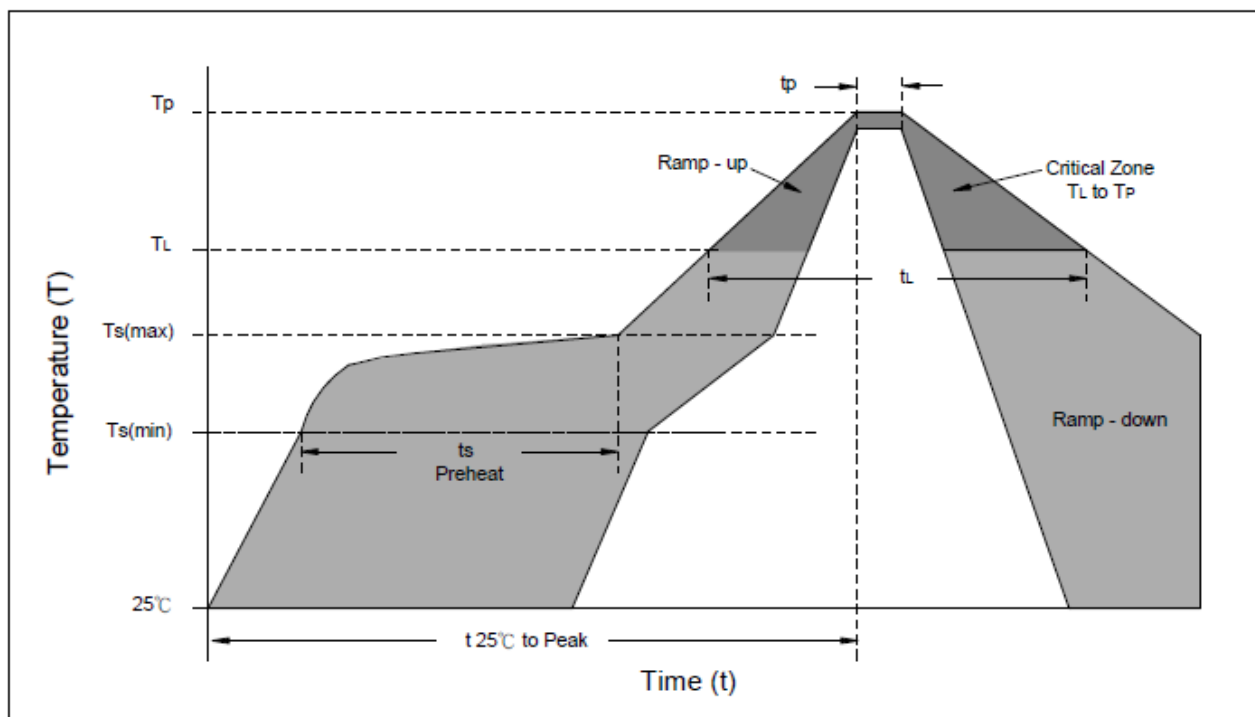


TEDST2312750B02		Pin 1 to 3/ Pin 2 to 3			Pin 3 to 1/ Pin3 to 2			Unit	Test Condition
Parameter	Symbol	Min	Typ.	Max	Min	Typ.	Max		
Reverse Working Voltage	V_{RWM}			12			7	V	
Breakdown Voltage	V_{BR}	13.5			7.5			V	$I_T = 1\text{mA}$
Reverse Leakage Current	I_R			0.05			2	μA	$V_R = V_{RWM}$
Clamping Voltage	V_C			20			10	V	$I_{PP} = 5\text{A}$ (8 x 20 μs pulse)
Clamping Voltage	V_C			26			12	V	$I_{PP} = 17\text{A}$ (8 x 20 μs pulse)
Junction Capacitance	C_J			75			75	pF	$V_R = 0\text{V}$, $f = 1\text{MHz}$

TEDST2324280B		Pin 1 to 3/ Pin 2 to 3			Pin 3 to 1/ Pin3 to 2			Unit	Test Condition
Parameter	Symbol	Min	Typ.	Max	Min	Typ.	Max		
Reverse Working Voltage	V_{RWM}			24				V	
Breakdown Voltage	V_{BR}	27						V	$I_T = 1\text{mA}$
Reverse Leakage Current	I_R			0.2				μA	$V_R = V_{RWM}$
Clamping Voltage	V_C			40				V	$I_{PP} = 1\text{A}$ (8/20 μs pulse)
Junction Capacitance	C_J			20				pF	$V_R = 0\text{V}$, $f = 1\text{MHz}$, Pin 1 to Pin 3 or Pin 2 to Pin 3

TEDST2324280U		Pin 1 to 3/ Pin 2 to 3			Pin 3 to 1/ Pin3 to 2			Unit	Test Condition
Parameter	Symbol	Min	Typ.	Max	Min	Typ.	Max		
Reverse Working Voltage	V_{RWM}			24				V	
Breakdown Voltage	V_{BR}	26.7						V	$I_T = 1\text{mA}$
Reverse Leakage Current	I_R		0.01	0.5				μA	$V_R = V_{RWM}$
Clamping Voltage	V_C		33					V	$I_{PP} = 1\text{A}$ (8/20 μs pulse)
			45					V	$I_{PP} = 6\text{A}$ (8/20 μs pulse)
Junction Capacitance	C_J			70				pF	$V_R = 0\text{V}$, $f = 1\text{MHz}$, Pin 1 to Pin 3 or Pin 2 to Pin 3
				35				pF	$V_R = 0\text{V}$, $f = 1\text{MHz}$, Pin 1 to Pin 2

■ Soldering Recommendation



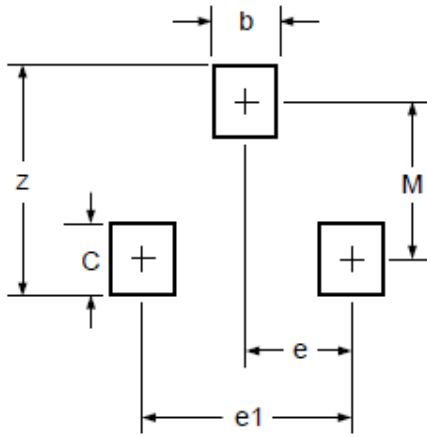
Reflow Condition	Lead-free assembly
Preheat -Temperature Min(Ts min) -Temperature Min(Ts max) -Time (min to max) (ts)	150°C 200°C 60 – 180 seconds
Average ramp up rate -Temperature Liquidus (TL) to peak	3°C/second max
Ts(max) to TL -Ramp-up Rate	3°C/second max.
Reflow -Temperature Liquidus (TL) -Time (tL)	217°C 60 – 150 seconds
Peak Temperature (TP)	260°C
Time within 5°C of actual peak Temperature(tp)	20 – 40 seconds
Ramp-down Rate	6°C/second max.
Time 25°C to peak Temperature(TP)	8 minutes max.
Do not exceed	260°C

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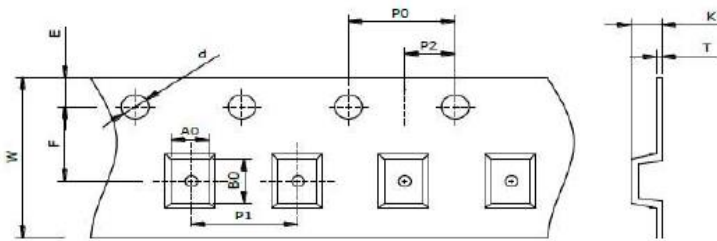
Recommended Soldering Pad Dimensions



Unit: mm

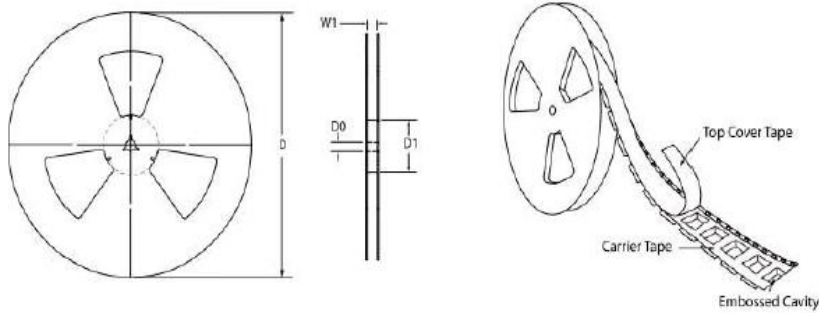
Symbol	SOT-23
M	2.02
C	0.8
Z	2.82
e	0.95 BSC
e1	1.90 BSC
b	0.8

Packaging



Unit: mm

Symbol	SOT-23
A0	3.10 ± 0.10
B0	2.70 ± 0.10
K	1.15 ± 0.10
d	1.50 ± 0.10
D	178.00 ± 2.00
D0	13.00 ± 0.20
D1	MIN. 54.00
E	1.75 ± 0.10
F	3.50 ± 0.10
P0	4.00 ± 0.10
P1	4.00 ± 0.10
P2	2.00 ± 0.10
T	0.20 ± 0.05
W	8.00 ± 0.20
W1	MAX. 13.50



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■ Quantity

MPQ: 3,000pcs

Package Type	Reel Size (inch)	Reel (Kpcs)
SOT-23	7	3

■ Warehouse Storage Conditions of product

- Storage condition:
 1. Storage Temperature: $-10^{\circ}\text{C} \sim +40^{\circ}\text{C}$
 2. Relative Humidity: $\leq 75\% \text{RH}$
 3. Keep away from corrosive atmosphere and sunlight.
- Period of Storage: 1 year.